

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/595809	Confirmation No.	7041
Applicant	:	Shinji Okamoto et al.		
Filed	:	May 12, 2006		
TC/A.U.	:	N/A		
Examiner	:	N/A		
Title	:	CONNECTOR CHIP AND MANUFACTURING METHOD THEREOF		
Docket No.	:	NIS-16657		
Customer No.	:	040854		

**LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir/Madam:

Enclosed is the English translation of the above-identified application, along with a Certificate of Verification signed by the translator. The \$130.00 fee for filing a non-English specification was included in the filing fee paid on May 12, 2006. Please charge the \$200.00 fee for one independent claim in excess of three to our Deposit Account No. 18-0160 Order No. NIS-16657.

If there are any additional fees as a result of this communication, please charge same to our Deposit Account No. 18-0160 Order No. NIS-16657.

Respectfully submitted,

RANKIN, HILL, PORTER & CLARK LLP

By                     /David E. Spaw/                      
David E. Spaw, Reg. No. 34732

4080 Erie Street  
Willoughby, Ohio 44094-7836  
(216) 566-9700

July 12, 2006

## VERIFICATION OF TRANSLATION

I, the undersigned, am a professional translator, fully competent to translate from Japanese to English, and I hereby declare that the attached English rendition,

Entitled: CONNECTOR CHIP AND MANUFACTURING METHOD  
THEREOF

is a genuine translation, accurate in every particular, to the best of my ability and knowledge, of the Japanese text identified as PCT/JP2004/016847 and also identified as US Serial No. 10/595809.

Date: 7 July 2006

Signature: T. Kuribayashi

Typed name: Takako Kuribayashi

Title: Technical Translator

Address: c/o Nishiura & Associates

Toranomon 34 MT Bldg. 9F

25-5, Toranomon 1-chome

Minato-ku, Tokyo 105-0001

Japan